



# Materials, Design & Manufacturing Facility (CWB) 材料、設計和製造中心(清水灣)

# MDMF (CWB)

# Introduction

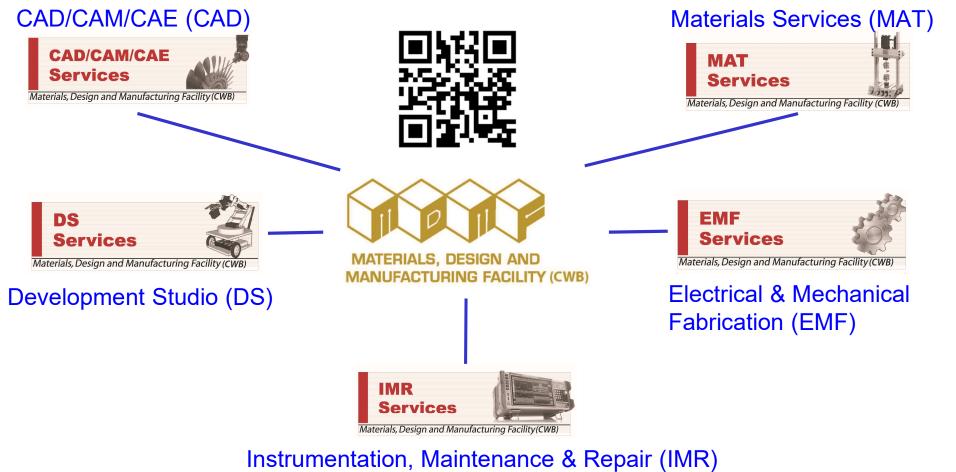
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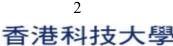


#### **Our Services – 5 Units**



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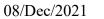






#### **Services Scope – EMF**

- Engineering design and fabrication supporting services
- Sophisticated mechanical & electrical parts/equipment for the university and industrial collaboration projects
  - Parts/equipment/controller is not available in market
  - Multidisciplinary and application oriented activities



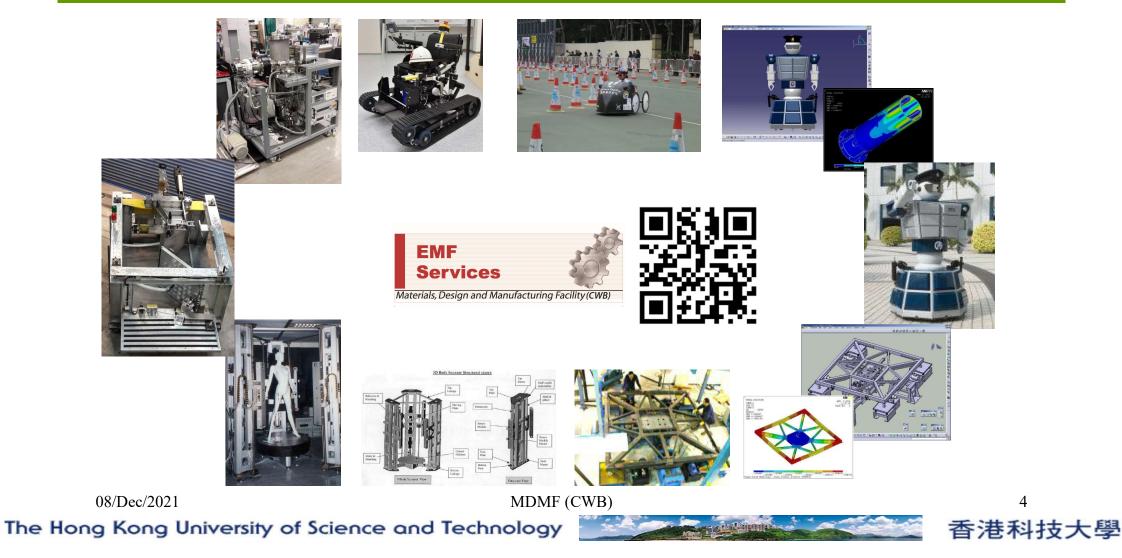
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#### **Services Scope – EMF**

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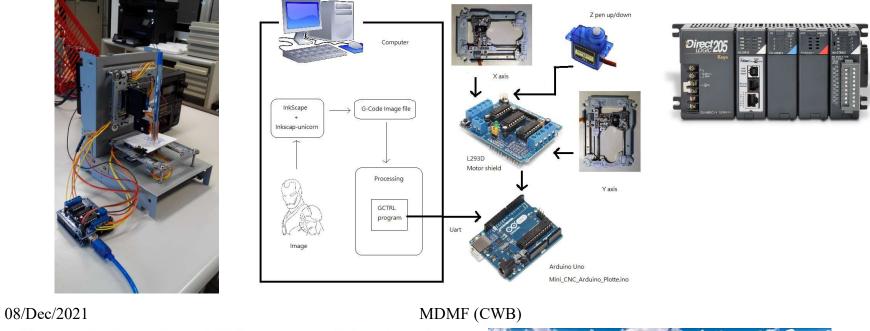
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#### **Services Scope – DS**

#### • Controller design and fabrication supporting

- Controller boards, MCUs, cam, motors, sensors (environmental, motion, light, etc.)
- Eclipse for android development, Arduino IDE, Raspberry Pi, PLC
- PCB prototyping







#### **Services Scope - IMR**

- Repair and maintenance of equipment
  - Scientific instruments, computer control machineries, laboratory equipment, and electrical safety
  - Especially for those which are no longer supported by the manufacturers
- Calibrations for multimeter, power meter, data logger, radiation monitor and temperature sensors





#### **Services Scope - IMR**

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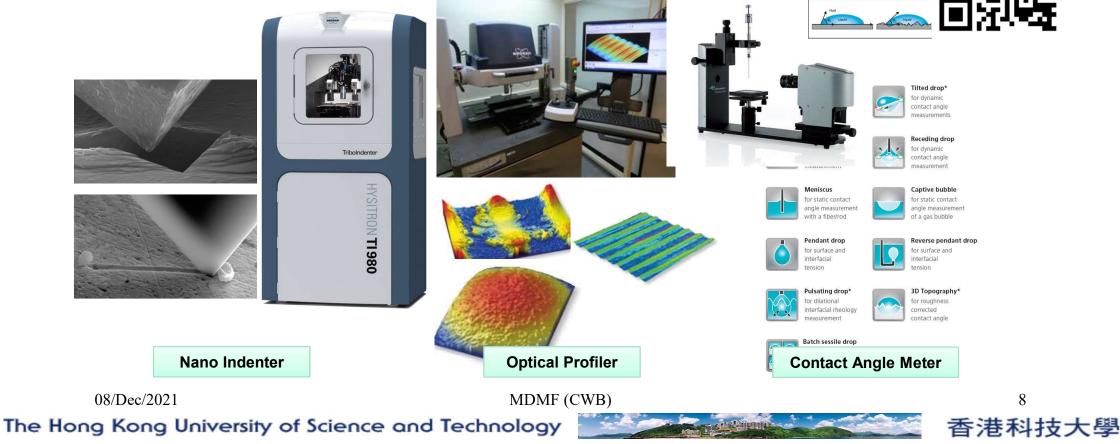






#### **Services Scope - CAD**

- Nano-measurement
  - Nano indenter, 3D surface metrology, optical profiler, contact angle meter

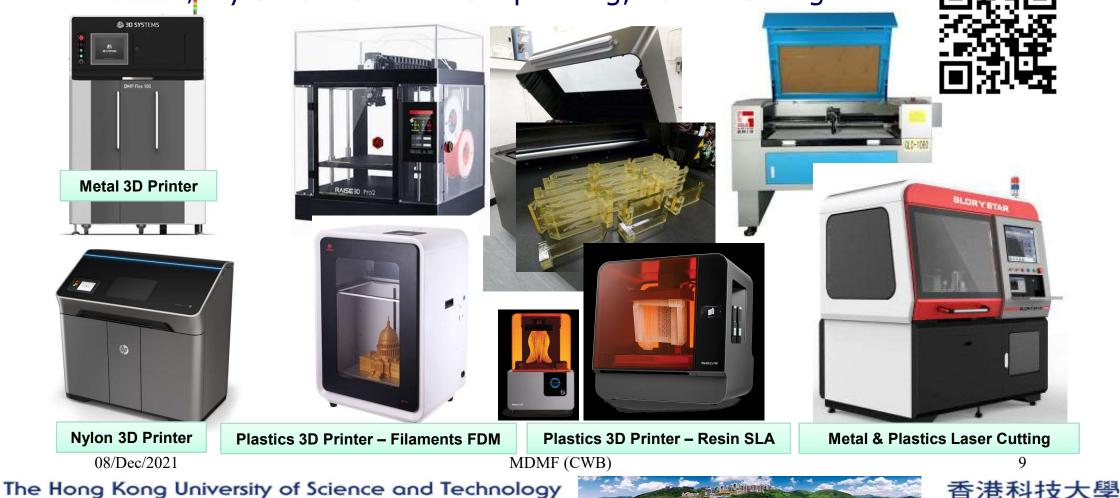






#### **Services Scope - CAD**

• Metal, Nylon & Plastics - 3D printing, Laser cutting

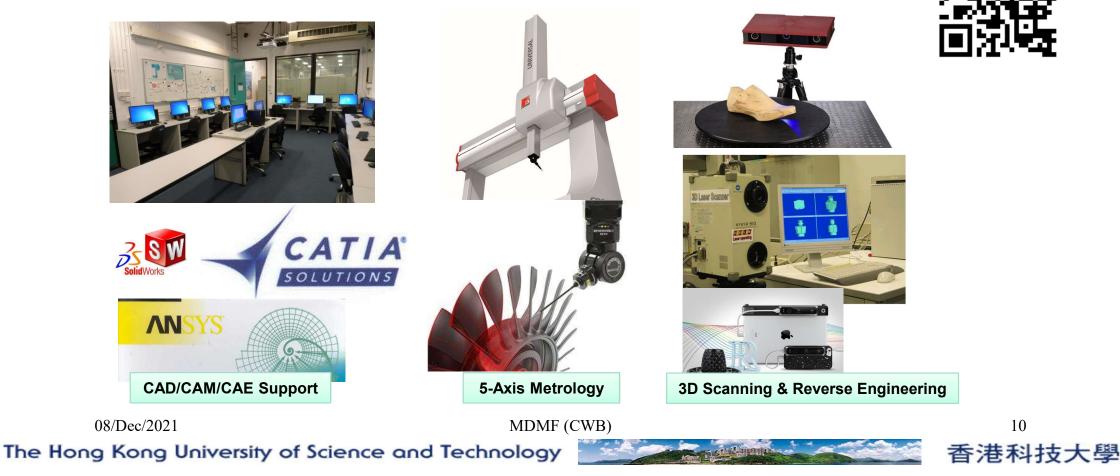






#### **Services Scope - CAD**

CAD/CAM/CAE system support, 5-axis metrology, 3D scanning, reverse engineering







- Mechanical Testing
  - also known as destructive testing, reveals the properties of a material under dynamic or static force



MTS 810 5KN to 100KN



MTS 858 15kN Axial and 100 Nm Torsion

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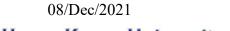


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MTS 858 Mini Bionix 25KN Axial, 250 Nm Torsional







- Inspection and Failure Analysis
  - determining the root cause of parts/assembly failure and working out the means for correcting and preventing current/future problems



Zeta Potential / Nano-particle Analyzer: ZetaPlus Zeta Potential Range : -150 to + 150 mV Size Range : 10nm to30µm



TecScan 7 Axis Immersion Scanner 1600mm x 800mm x 800mm sample length





C-SAM: Sonix Quantum 350H Spatial resolution:0.5 μm Depth resolution: 8 μm

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- Inspection and Failure Analysis
  - determining the root cause of parts/assembly failure and working out the means for correcting and preventing current/future problems



Particle Size Analyzer Measurement capability from 0.01 to 2800 microns



Microscope: Topcon TMM-13OZ Measuring range: 130 x 130 x 50 mm Minimum indication: 0.001 mm Accuracy: (3 + 2.5L/100) μm

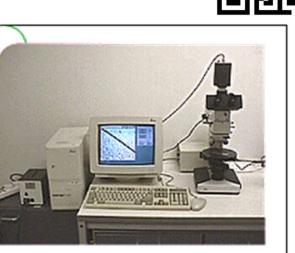


Image Processing System Leica QUANTIMET 500+

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- Sample Processing
  - processing of metal heat treatment, polymer and carbon composite



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# **Project – Metal Laser Cutting**

#### • Fiber laser cutting machine of 1.5kW

- Working area: 630 x 530 x 90 mm
- 4th rotary axis for round pipe cutting



Mild Steel (mm) 0.2 ~ 16 Stainless Steel (mm) 0.2 ~ 8 Aluminum (mm) 0.5 ~ 5 Copper (mm) 0.5 ~ 2 Brass (mm) 0.5 ~ 4





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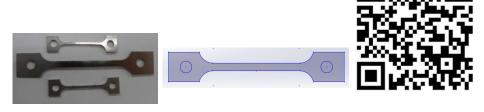






# **Project – Metal Laser Cutting**

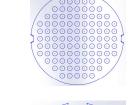
- Examples
  - SMA specimens
    - Tensile specimen:
      - Materials / Thickness: 1mm
      - Production time: 45 second
    - Crack specimen:
      - Materials / Thickness: 1.5mm
      - Production time:1 min.





- S.S. Filter specimen
  - Materials / Thickness: 1.2mm
  - Production time:8min. 30 second
- Ti Electrode specimen
  - Materials / Thickness: 1mm
  - Production time: 2min.







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# **Project – Laser Marking & Engraving**

- Laser Marking Machine
  - 10W fiber laser
  - Max. size is 110mm X 110mm





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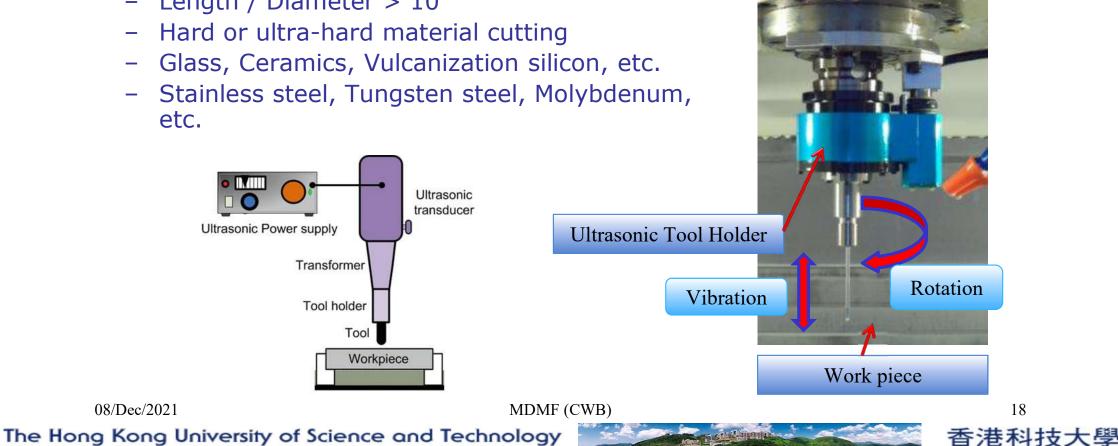






#### **Project – Ultrasonic-Assisted Machining**

- Ultrasonic tool holder
  - Fast, small and deep hole machining
  - Length / Diameter > 10 —
  - Hard or ultra-hard material cutting
  - Glass, Ceramics, Vulcanization silicon, etc. \_
  - Stainless steel, Tungsten steel, Molybdenum, etc.

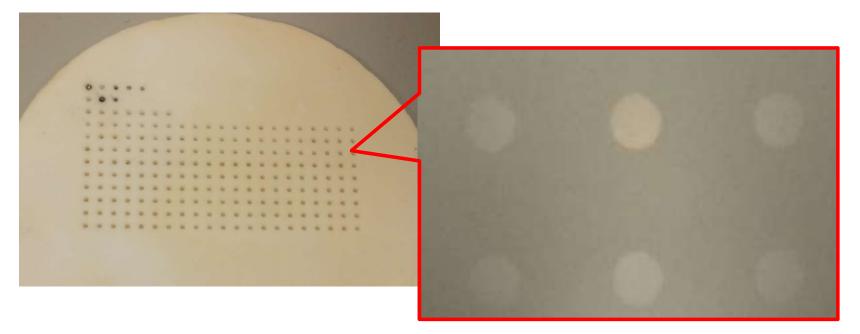






### **Project – Ultrasonic-Assisted Machining**

- Examples
  - Alumina, Small hole drilling / milling (blind hole)
    - Hole diameter = 1.2mm; depth = 1.4mm
    - # of holes to be drilled per workpiece = 400







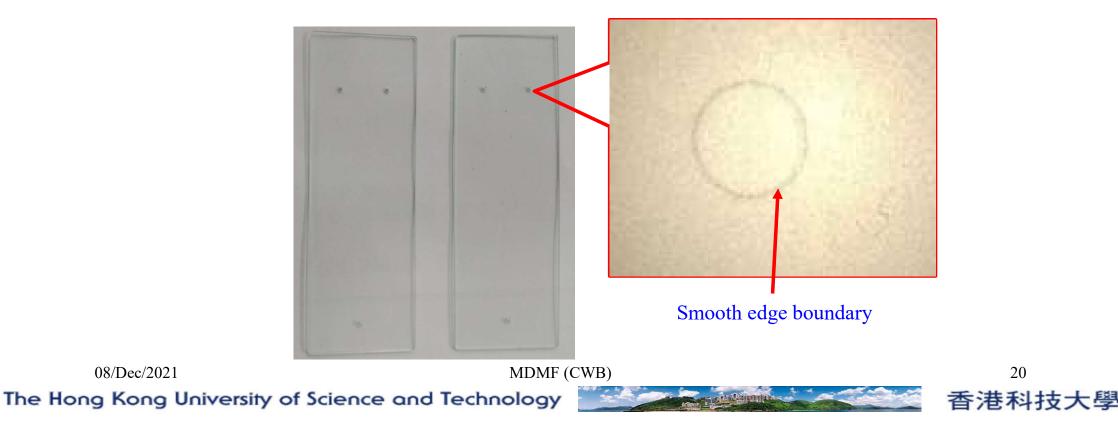


# **Project – Ultrasonic-Assisted Machining**

Examples 

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- Glass, Small hole drilling (thru' hole)
  - Hole diameter = 0.6mm; Glass plate thickness = 1mm
  - # of holes to be drilled per workpiece = 4 •







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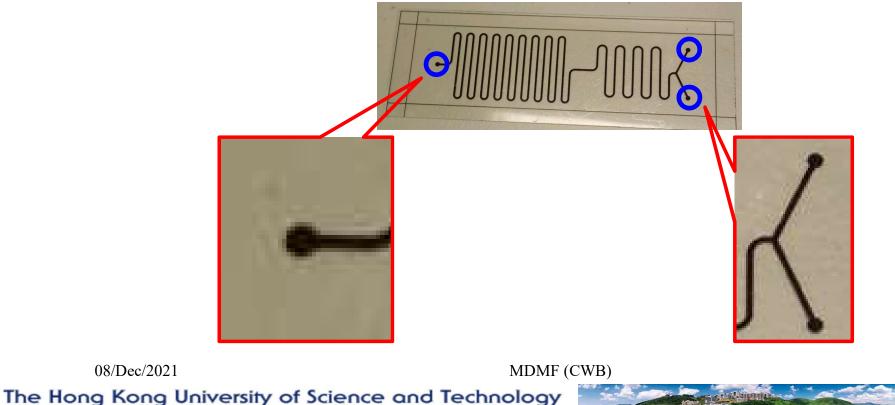
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## **Project – Ultrasonic-Assisted Machining**

Examples 

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- Glass channel, Small hole drilling (thru' hole) —
  - Hole diameter = 1.0mm; depth = 1mm
  - # of holes to be drilled per workpiece = 3







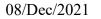
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### **Project – Ultrasonic-Assisted Machining**

- Examples
  - Stainless steel, Small hole drilling (blind hole)
    - Hole diameter = 0.2mm and 0.9mm
    - Depth = 5mm and 20mm
  - SMA Shape Memory Alloy, Small hole drilling (thru' hole)
    - Hole diameter = 0.075m
    - Thickness = 2mm



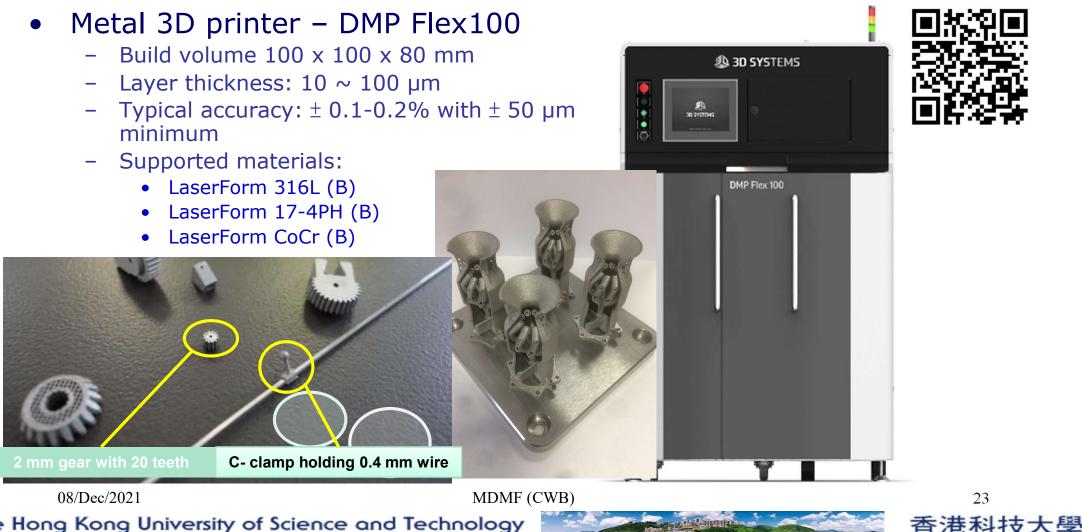


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# **Project – Metal 3d Printing**

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# **Project – Nylon 3d Printing**

#### • Nylon 3D printer – HP Jet Fusion 540

- Build volume 332 x 190 x 248 mm
- Layer thickness: 0.08 mm
- Typical accuracy: ± 0.3% with ± 0.2 mm minimum
- Supported materials:
  - Nylon PA12

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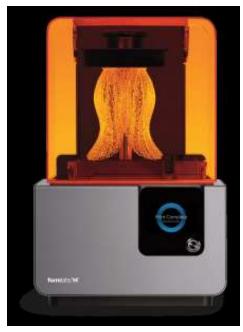
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#### • Desktop SLA 3D printer – Form 2

- Build volume 145 x 145 x 175 mm
- Layer Thickness 0.025 0.1 mm
- File Formats for Printing: STL, OBJ
- Professional print quality









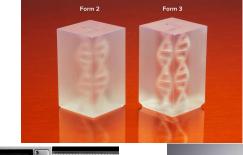






#### • Desktop SLA 3D printer – Form 3L

- Build volume 335 x 200 x 300 mm
- Layer Thickness 0.025 0.3 mm
- File Formats for Printing: STL, OBJ
- Low Force Stereolithography (LFS)<sup>™</sup>



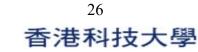








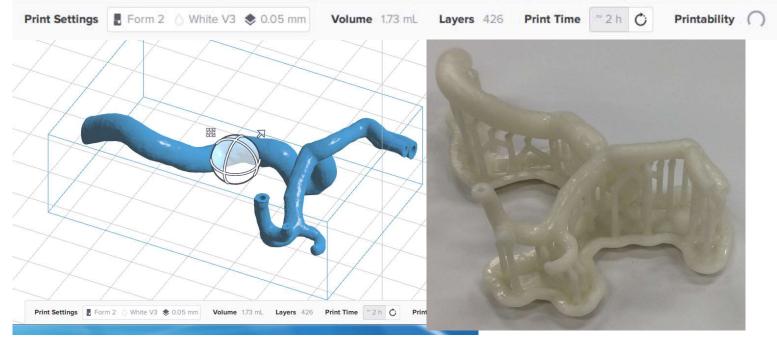
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- Examples
  - Blood vessel
    - Materials Standard White
    - Minimum feature size = 0.5mm

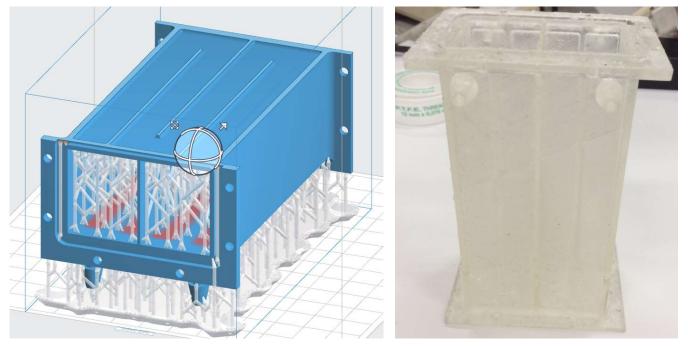


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- Water channel model
  - Materials Standard Clear
  - Channel size = 2.5mm
  - Internal water circulation



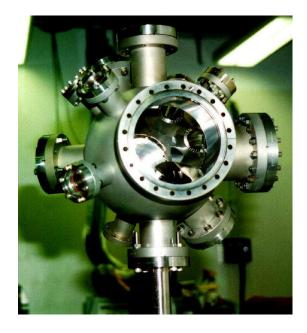


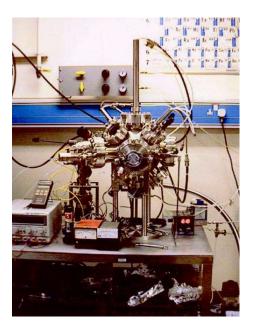




# **Project – High Vacuum Chamber**

- High vacuum stainless steel chamber
  - Design and build an enhanced HVC with tailor made functionalities
  - Vacuum level less than 10<sup>-8</sup> torr









# **Project – Reactive Ion Etcher**

- Design and build the reactive ion etcher in wafer fabrication
  - Tailor made functionalities





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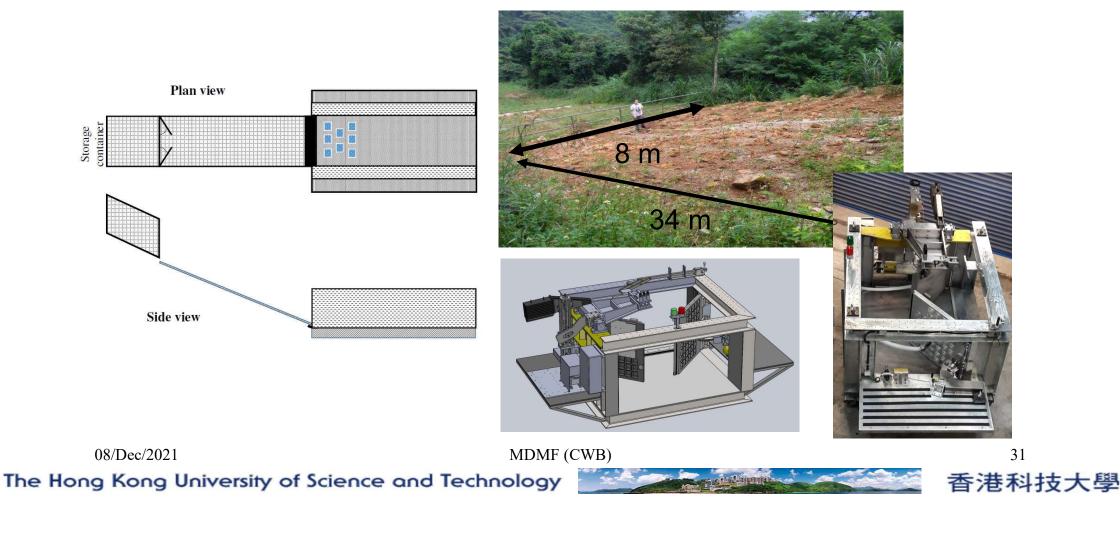






# **Project – Soil Retaining Gate**

• Design and build the soil retaining gate of a flume model







# **Project – Shaking Platform**

- Design and build the shaking platform for
  - Active vibration control of earthquake / wind excited structures
  - Assessment of motion acceptance criteria for human occupancy in the design of flexible structures









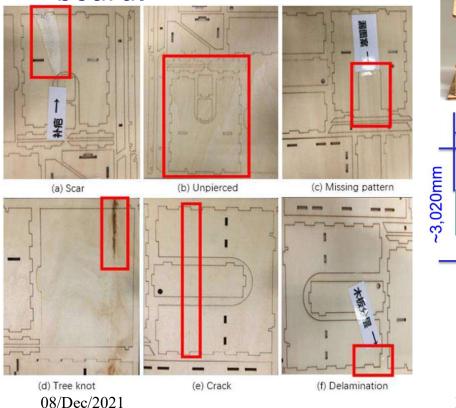
#### **Project – Automatic Flaws Inspection System**

 To automate the detection process of natural and manufacturing flaws before/after laser cutting a plywood board.

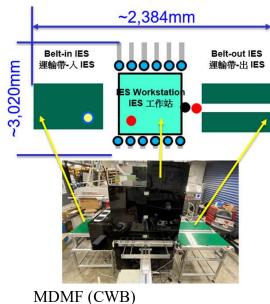


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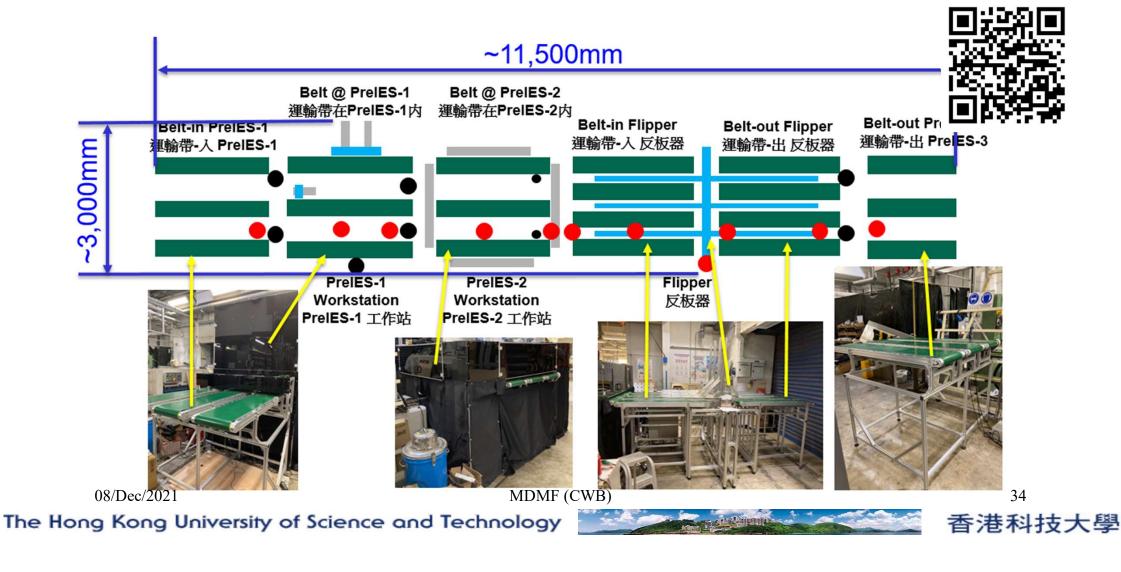








#### **Project – Automatic Flaws Inspection System**

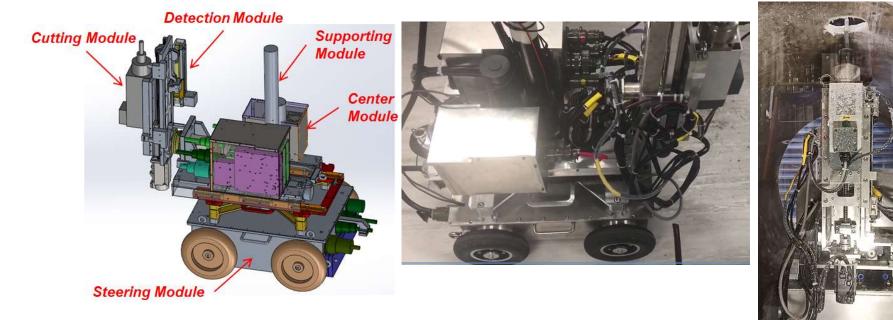






# **Project – CIPP Repair Robot Cutter**

• To develop an automatic robot cutter that can cut the lateral connection branch opening during underground drainage pipe repairing in Hong Kong.



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### **Project – Diamond Sorter**

- An automation system to sort gems into different size / color / shape / transparency grades and to measure the cutting / cracks on diamonds
  - Involves the R&D of a vision system, image processing module and an electromechanical mechanism





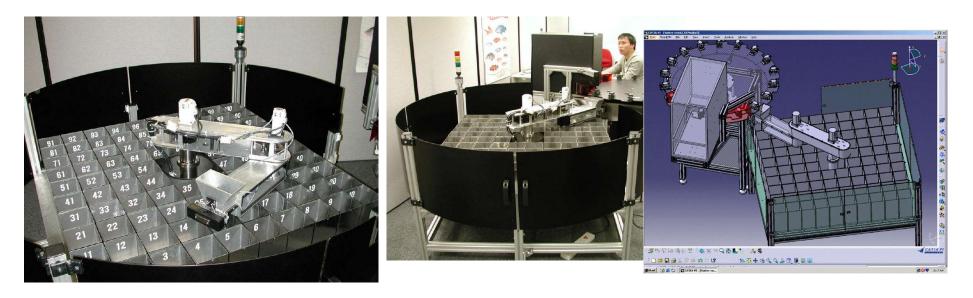




#### **Project – Feather Sorter**

- To sort feathers of different features for the shuttlecock manufacturing industry.
  - Involves the R&D of a turning table, an image processing system and a robotic arm, which selects feather into the bin matrix according to their degree of curvature











# **Project – Controller for Embroidery Machine**

- Design and develop a controller to control the embroidery machine more precisely and at higher speed, with less vibration
  - Linux in an embedded system, with advanced control algorithms for accurate positioning, tension control, automatic compensation

of vibration





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#### **Engineering / Robotic Design Competition**

- RoboCon
- ROV
- Cybathlon
- Pedal Kart
- Power Bike











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